# 2SB1148, 2SB1148A

### Silicon PNP epitaxial planar type

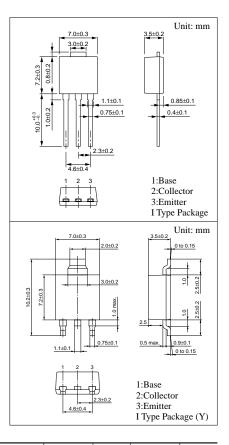
For low-voltage switching Complementary to 2SD1752 and 2SD1752A

#### Features

- ullet Low collector to emitter saturation voltage  $V_{\text{CE(sat)}}$
- High-speed switching
- I type package enabling direct soldering of the radiating fin to the printed circuit board, etc. of small electronic equipment.

#### Absolute Maximum Ratings (T<sub>C</sub>=25°C)

Parameter		Symbol	Ratings	Unit	
Collector to 2SI	B1148	V	-40	V	
base voltage 2SI	B1148A	$V_{CBO}$	-50	V	
Collector to 2SI	B1148	77	-20	V	
emitter voltage 2SI	B1148A	$V_{CEO}$	-40		
Emitter to base voltage		$V_{EBO}$	<b>-7</b>	V	
Peak collector current		$I_{CP}$	-20	A	
Collector current		$I_C$	-10	A	
Collector power T <sub>C</sub>	=25°C	D	15	337	
dissipation Ta	=25°C	$P_{C}$	1.3	W	
Junction temperature		T <sub>j</sub>	150	°C	
Storage temperature		$T_{stg}$	-55 to +150	°C	



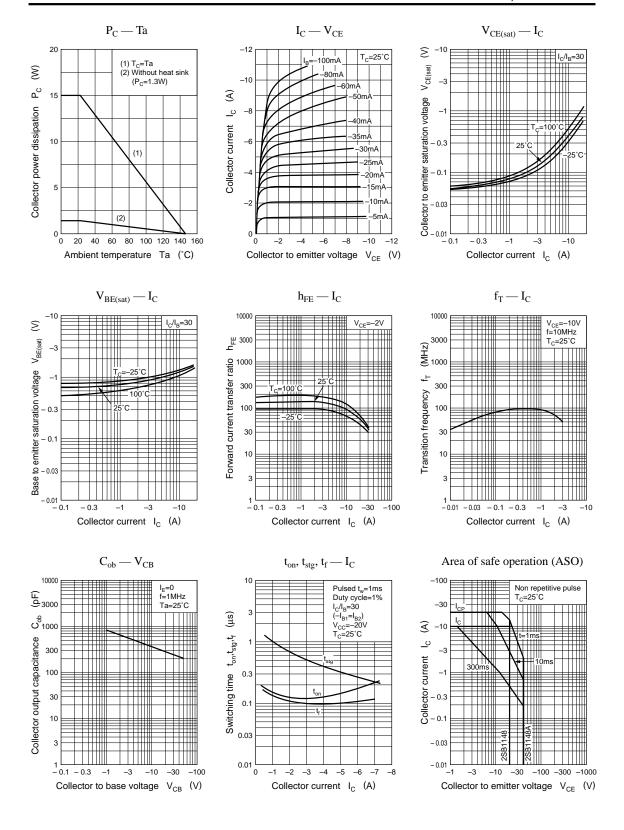
#### Electrical Characteristics (T<sub>C</sub>=25°C)

Paramete	er	Symbol	Conditions	min	typ	max	Unit	
Collector cutoff	2SB1148	_	$V_{CB} = -40V, I_{E} = 0$			-50		
current	2SB1148A	$I_{CBO}$	$V_{CB} = -50V, I_{E} = 0$			-50	μΑ	
Emitter cutoff curren	t	$I_{EBO}$	$V_{EB} = -5V, I_C = 0$			-50	μА	
Collector to emitter	2SB1148	**	$V_{CEO}$ $I_C = -10$ mA, $I_B = 0$	-20			V	
voltage	2SB1148A	V <sub>CEO</sub>		-40				
Forward current transfer ratio		h <sub>FE1</sub>	$V_{CE} = -2V, I_{C} = -0.1A$	45				
		h <sub>FE2</sub> *	$V_{CE} = -2V, I_C = -3A$	90		260		
Collector to emitter satu	uration voltage	V <sub>CE(sat)</sub>	$I_C = -10A, I_B = -0.33A$			- 0.6	V	
Base to emitter satura	ation voltage	V <sub>BE(sat)</sub>	$I_C = -10A, I_B = -0.33A$			-1.5	V	
Transition frequency		$f_T$	$V_{CE} = -10V, I_{C} = -0.5A, f = 10MHz$		100		MHz	
Collector output capa	ncitance	C <sub>ob</sub>	$V_{CB} = -10V$ , $I_E = 0$ , $f = 1MHz$		400		pF	
Turn-on time				0.1		μs		
Storage time		t <sub>stg</sub>	$I_C = -3A$ , $I_{B1} = -0.1A$ , $I_{B2} = 0.1A$ ,		0.5		μs	
Fall time		t <sub>f</sub>	$V_{CC} = -20V$		0.1		μs	

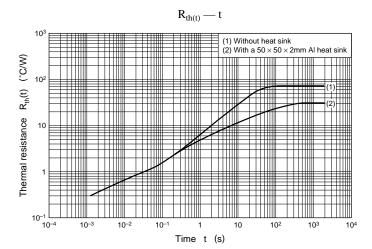
#### \*h<sub>FE2</sub> Rank classification

Rank	Q	P		
h <sub>FE2</sub>	90 to 180	130 to 260		

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